

# 54ABT16244

*54ABT16244 16-Bit Buffer/Line Driver with TRI-STATE Outputs*



Literature Number: SNOS050A

## 16-Bit Buffer/Line Driver with TRI-STATE® Outputs

### General Description

The 'ABT16244 contains sixteen non-inverting buffers with TRI-STATE outputs designed to be employed as a memory and address driver, clock driver, or bus oriented transmitter/receiver. The device is nibble controlled. Individual TRI-STATE control inputs can be shorted together for 8-bit or 16-bit operation.

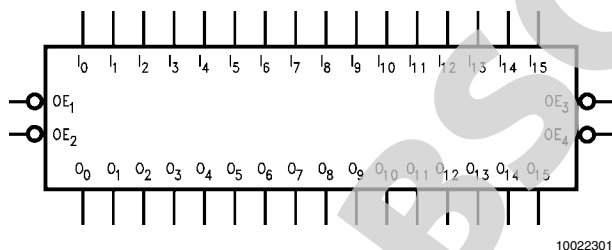
### Features

- Separate control logic for each nibble
- 16-bit version of the 'ABT244
- Outputs sink capability of 48 mA, source capability of 24 mA
- Guaranteed output skew
- Guaranteed multiple output switching specifications
- Output switching specified for both 50 pF and 250 pF loads
- Guaranteed simultaneous switching noise level and dynamic threshold performance
- Guaranteed latchup protection
- High impedance glitch free bus loading during entire power up and power down cycle
- Non-destructive hot insertion capability
- Standard Microcircuit Drawing (SMD) 5962-9317402

### Ordering Code

Military	Package Number	Package Description
54ABT16244W-QML	WA48A	48-Lead Cerpack

### Logic Symbol

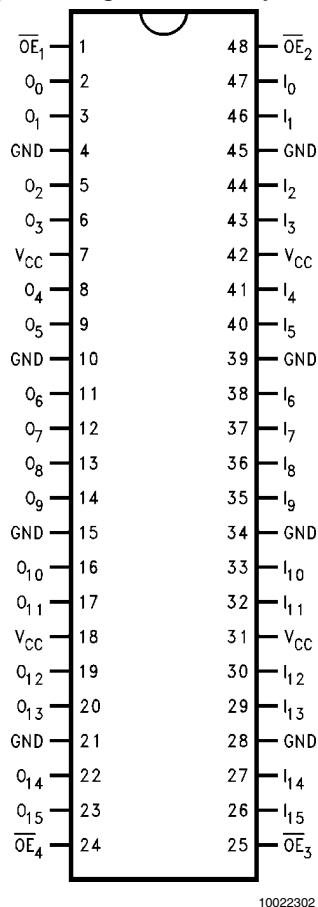


### Pin Descriptions

Pin Names	Description
$\overline{OE}_n$	Output Enable Inputs (Active Low)
$I_0-I_{15}$	Inputs
$O_0-O_{15}$	Outputs

### Connection Diagram

Pin Assignment for Cerpack



## Functional Description

The 'ABT16244 contains sixteen non-inverting buffers with TRI-STATE outputs. The device is nibble (4 bits) controlled with each nibble functioning identically, but independent of the other. The control pins can be shorted together to obtain full 16-bit operation.

## Truth Table

Inputs		Outputs
$\overline{OE}_1$	$I_0-I_3$	$O_0-O_3$
L	L	L
L	H	H
H	X	Z

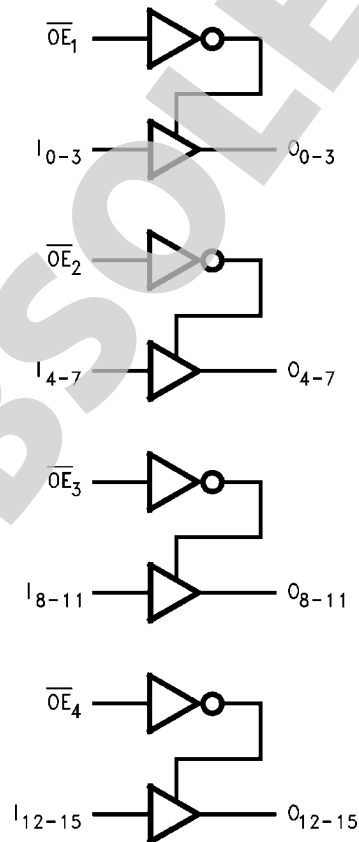
Inputs		Outputs
$\overline{OE}_3$	$I_8-I_{11}$	$O_8-O_{11}$
L	L	L
L	H	H
H	X	Z

Inputs		Outputs
$\overline{OE}_2$	$I_4-I_7$	$O_4-O_7$
L	L	L
L	H	H
H	X	Z

Inputs		Outputs
$\overline{OE}_4$	$I_{12}-I_{15}$	$O_{12}-O_{15}$
L	L	L
L	H	H
H	X	Z

H = High Voltage Level  
L = Low Voltage Level  
X = Immaterial  
Z = High Impedance

## Logic Diagram



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**Absolute Maximum Ratings** (Note 1)

Storage Temperature	-65°C to +150°C
Ambient Temperature under Bias	-55°C to +125°C
Junction Temperature under Bias	
Ceramic	-55°C to +175°C
V <sub>CC</sub> Pin Potential to Ground Pin	-0.5V to +7.0V
Input Voltage (Note 2)	-0.5V to +7.0V
Input Current (Note 2)	-30 mA to +5.0 mA
Voltage Applied to Any Output in the Disabled or Power-off State in the HIGH State	-0.5V to 5.5V -0.5V to V <sub>CC</sub>
Current Applied to Output in LOW State (Max)	twice the rated I <sub>OL</sub> (mA)

DC Latchup Source Current	-500 mA
Over Voltage Latchup (I/O)	10V

**Recommended Operating Conditions**

Free Air Ambient Temperature	
Military	-55°C to +125°C
Supply Voltage	
Military	+4.5V to +5.5V
Minimum Input Edge Rate	(ΔV/Δt)
Data Input	50 mV/ns
Enable Input	20 mV/ns

**Note 1:** Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

**Note 2:** Either voltage limit or current limit is sufficient to protect inputs.

**DC Electrical Characteristics**

Symbol	Parameter	ABT16244			Units	V <sub>CC</sub>	Conditions	
		Min	Typ	Max				
V <sub>IH</sub>	Input HIGH Voltage	2.0			V		Recognized HIGH Signal	
V <sub>IL</sub>	Input LOW Voltage			0.8	V		Recognized LOW Signal	
V <sub>CD</sub>	Input Clamp Diode Voltage			-1.2	V	Min	I <sub>IN</sub> = -18 mA	
V <sub>OH</sub>	Output HIGH Voltage	54ABT	2.5		V	Min	I <sub>OH</sub> = -3 mA	
		54ABT	2.0		V	Min	I <sub>OH</sub> = -24 mA	
V <sub>OL</sub>	Output LOW Voltage	54ABT		0.55	V	Min	I <sub>OL</sub> = 48 mA	
I <sub>IH</sub>	Input HIGH Current			5	μA	Max	V <sub>IN</sub> = 2.7V (Note 3)	
				5	μA	Max	V <sub>IN</sub> = V <sub>CC</sub>	
I <sub>BVI</sub>	Input HIGH Current Breakdown Test			7	μA	Max	V <sub>IN</sub> = 7.0V	
I <sub>IL</sub>	Input LOW Current			-5	μA	Max	V <sub>IN</sub> = 0.5V (Note 3)	
				-5	μA	Max	V <sub>IN</sub> = 0.0V	
V <sub>ID</sub>	Input Leakage Test	4.75			V	0.0	I <sub>ID</sub> = 1.9 μA All Other Pins Grounded	
I <sub>OZH</sub>	Output Leakage Current			50	μA	0 - 5.5V	V <sub>OUT</sub> = 2.7V; $\overline{OE}_n = 2.0V$	
I <sub>OZL</sub>	Output Leakage Current			-50	μA	0 - 5.5V	V <sub>OUT</sub> = 0.5V; $\overline{OE}_n = 2.0V$	
I <sub>OS</sub>	Output Short-Circuit Current			-100	-275	mA	Max	V <sub>OUT</sub> = 0.0V
I <sub>CEX</sub>	Output High Leakage Current			50	μA	Max	V <sub>OUT</sub> = V <sub>CC</sub>	
I <sub>ZZ</sub>	Bus Drainage Test			100	μA	0.0	V <sub>OUT</sub> = 5.5V All Other Pins GND	
I <sub>CCH</sub>	Power Supply Current			2.0	mA	Max	All Outputs HIGH	
I <sub>CCL</sub>	Power Supply Current			60	mA	Max	All Outputs LOW	
I <sub>CCZ</sub>	Power Supply Current			2.0	mA	Max	$\overline{OE}_n = V_{CC}$ All Others at V <sub>CC</sub> or GND	
I <sub>CCT</sub>	Additional I <sub>CC</sub> /Input	Outputs Enabled	2.5		mA		V <sub>I</sub> = V <sub>CC</sub> - 2.1V	
		Outputs TRI-STATE	2.5		mA	Max	Enable Input V <sub>I</sub> = V <sub>CC</sub> - 2.1V	
		Outputs TRI-STATE	50		μA		Data Input V <sub>I</sub> = V <sub>CC</sub> - 2.1V All Others at V <sub>CC</sub> or GND	
I <sub>CCD</sub>	Dynamic I <sub>CC</sub> (Note 3)	No Load		0.1	mA/ MHz	Max	Outputs Open, $\overline{OE}_n = GND$ One Bit Toggling, 50% Duty Cycle	

**Note 3:** Guaranteed but not tested.

## DC Electrical Characteristics

Symbol	Parameter	Min	Max	Units	V <sub>CC</sub>	Conditions C <sub>L</sub> = 50 pF, R <sub>L</sub> = 500Ω
V <sub>OLP</sub>	Quiet Output Maximum Dynamic V <sub>OL</sub>		1.1	V	5.0	T <sub>A</sub> = 25°C (Note 4)
V <sub>OLV</sub>	Quiet Output Minimum Dynamic V <sub>OL</sub>		-0.45	V	5.0	T <sub>A</sub> = 25°C (Note 4)

**Note 4:** Max number of outputs defined as (n). n – 1 data inputs are driven 0V to 3V. One output at LOW.

## AC Electrical Characteristics

Symbol	Parameter	54ABT		Units	Fig. No.
		T <sub>A</sub> = -55°C to +125°C V <sub>CC</sub> = 4.5V–5.5V C <sub>L</sub> = 50 pF			
		Min	Max		
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay Data to Outputs	0.5	5.3	ns	Figure 2
t <sub>PZH</sub> t <sub>PZL</sub>	Output Enable Time	1.5	6.8	ns	Figure 5
t <sub>PHZ</sub> t <sub>PLZ</sub>	Output Disable Time	1.5	7.7	ns	Figure 5

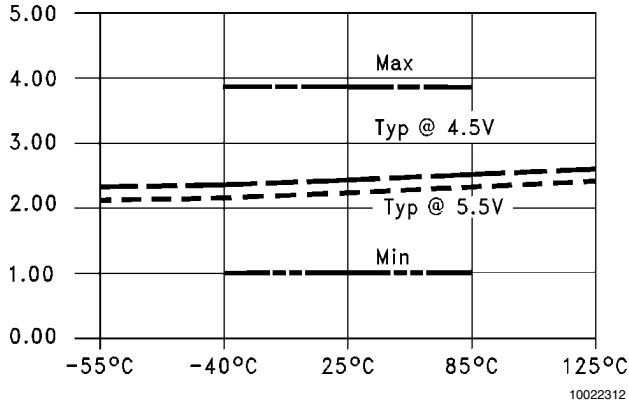
## Capacitance

Symbol	Parameter	Typ	Units	Conditions T <sub>A</sub> = 25°C
C <sub>IN</sub>	Input Capacitance	5.0	pF	V <sub>CC</sub> = 5.0V
C <sub>OUT</sub> (Note 5)	Output Capacitance	9.0	pF	V <sub>CC</sub> = 5.0V

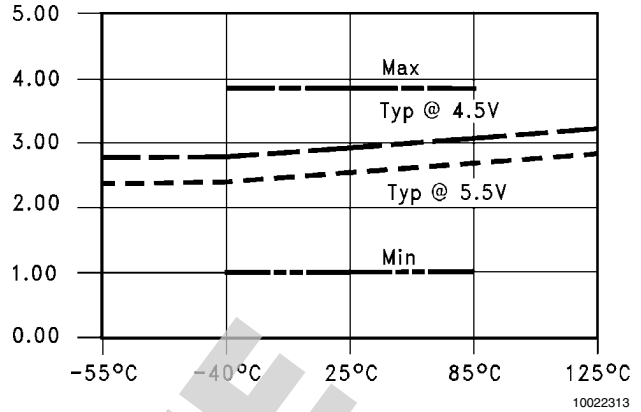
**Note 5:** C<sub>OUT</sub> is measured at frequency f = 1 MHz; per MIL STD-883B, Method 3012.

**Capacitance** Dashed lines represent design characteristics; for specified guarantees, refer to AC Characteristics Tables.

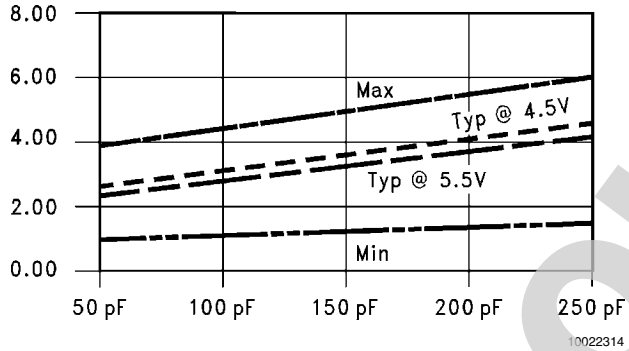
**$t_{PLH}$  vs Temperature ( $T_A$ )**  
 $C_L = 50$  pF, 1 Output Switching



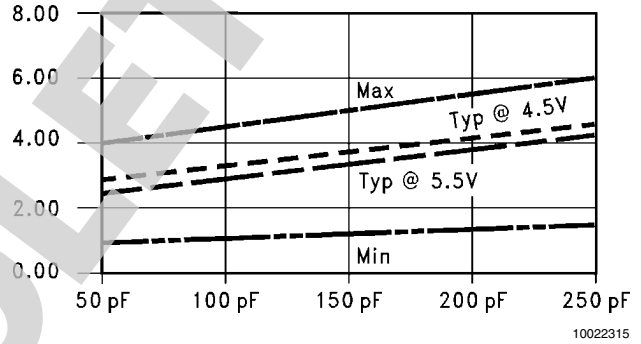
**$t_{PHL}$  vs Temperature ( $T_A$ )**  
 $C_L = 50$  pF, 1 Output Switching



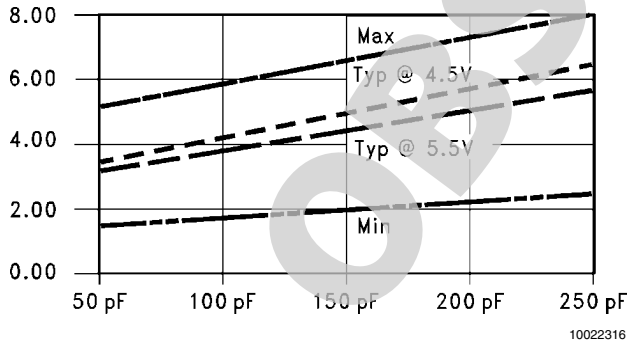
**$t_{PLH}$  vs Load Capacitance**  
 1 Output Switching,  $T_A = 25^\circ\text{C}$



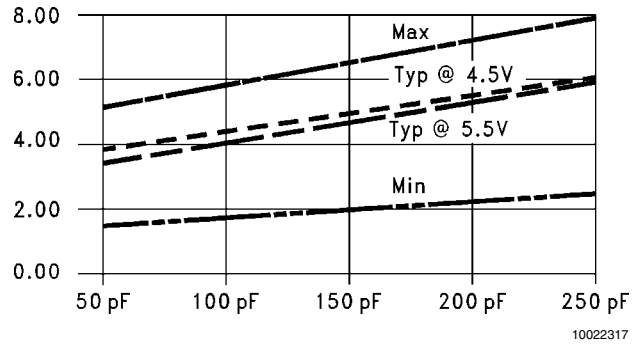
**$t_{PHL}$  vs Load Capacitance**  
 1 Output Switching,  $T_A = 25^\circ\text{C}$



**$t_{PLH}$  vs Load Capacitance**  
 16 Outputs Switching,  $T_A = 25^\circ\text{C}$

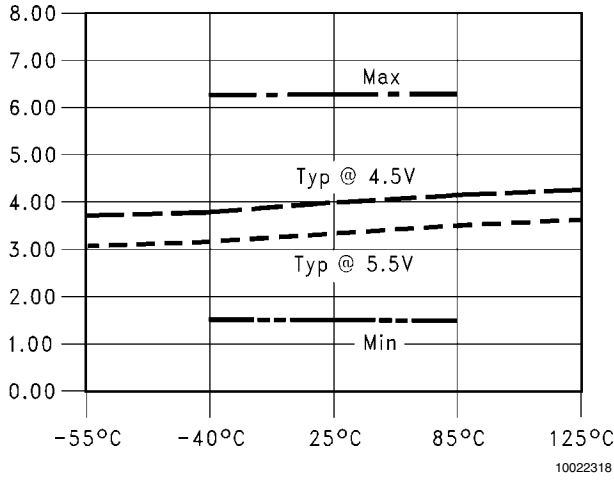


**$t_{PHL}$  vs Load Capacitance**  
 16 Outputs Switching,  $T_A = 25^\circ\text{C}$

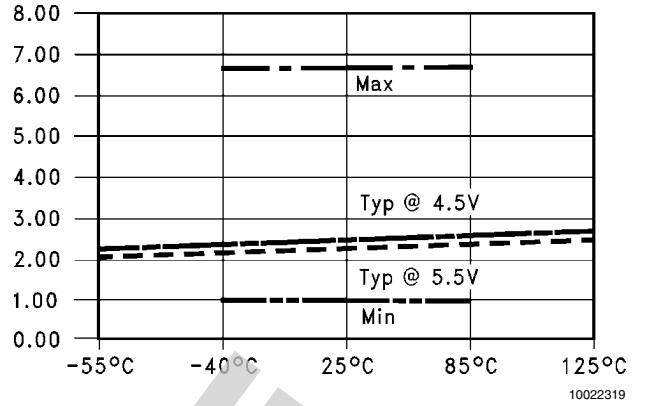


Note: Dashed lines represent design characteristics; for specified guarantees, refer to AC Characteristics Tables.

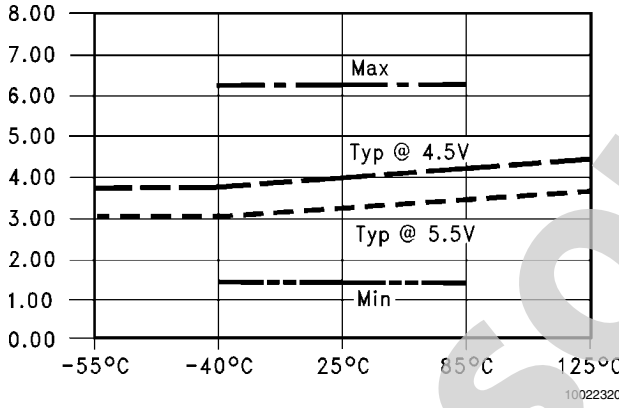
**$t_{pZL}$  vs Temperature ( $T_A$ )**  
 $C_L = 50$  pF, 1 Output Switching



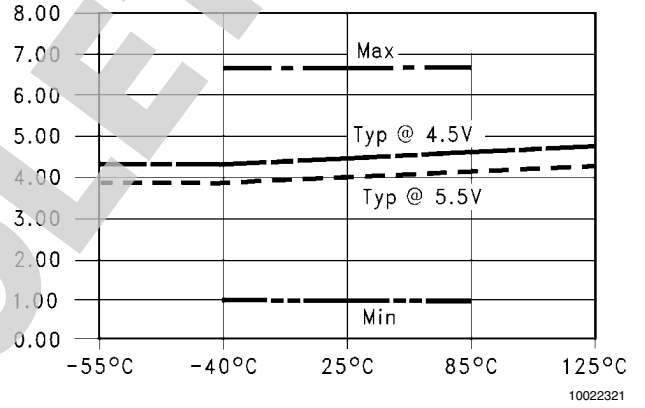
**$t_{pLZ}$  vs Temperature ( $T_A$ )**  
 $C_L = 50$  pF, 1 Output Switching



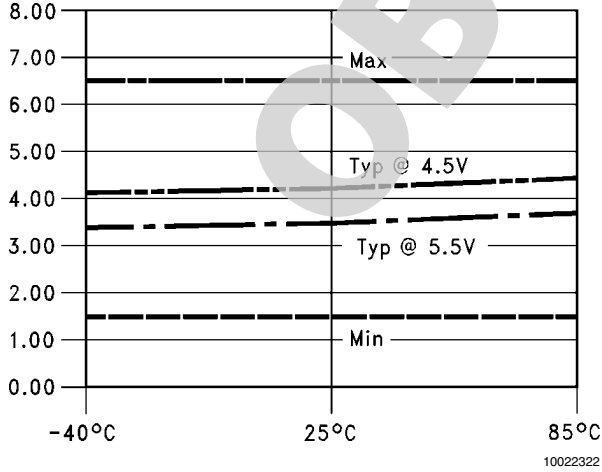
**$t_{pZH}$  vs Temperature ( $T_A$ )**  
 $C_L = 50$  pF, 1 Output Switching



**$t_{pHZ}$  vs Temperature ( $T_A$ )**  
 $C_L = 50$  pF, 1 Output Switching

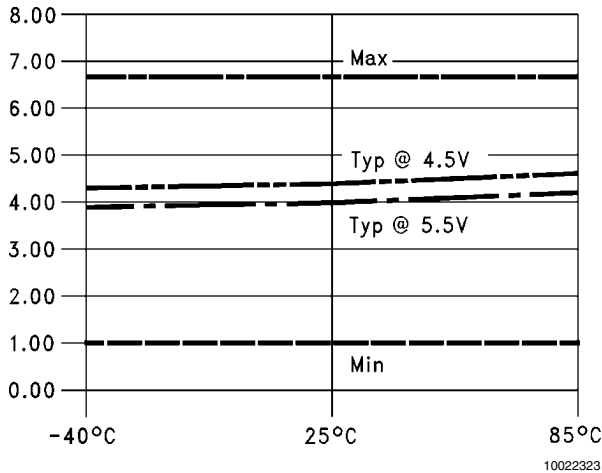


**$t_{pZH}$  vs Temperature ( $T_A$ )**  
 $C_L = 50$  pF, 16 Outputs Switching

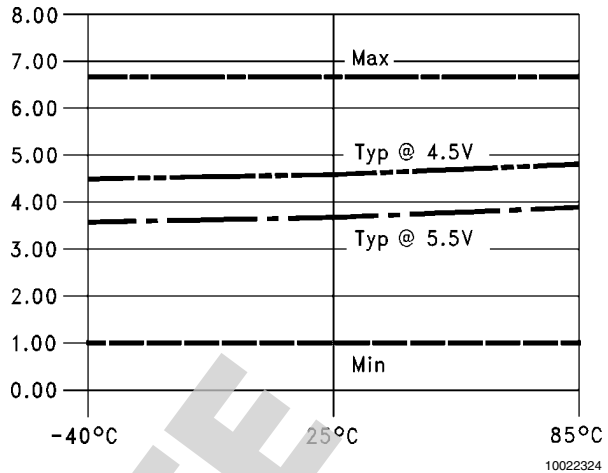


Note: Dashed lines represent design characteristics; for specified guarantees, refer to AC Characteristics Tables.

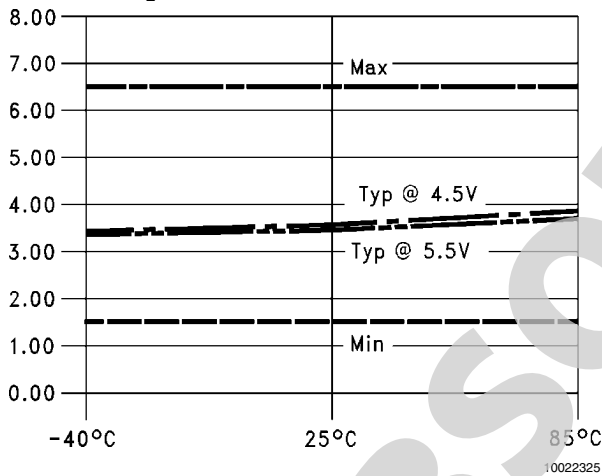
**$t_{PHZ}$  vs Temperature ( $T_A$ )**  
 $C_L = 50$  pF, 16 Outputs Switching



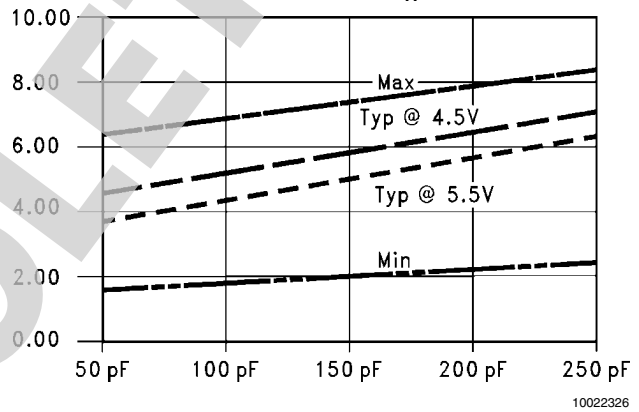
**$t_{PZL}$  vs Temperature ( $T_A$ )**  
 $C_L = 50$  pF, 16 Outputs Switching



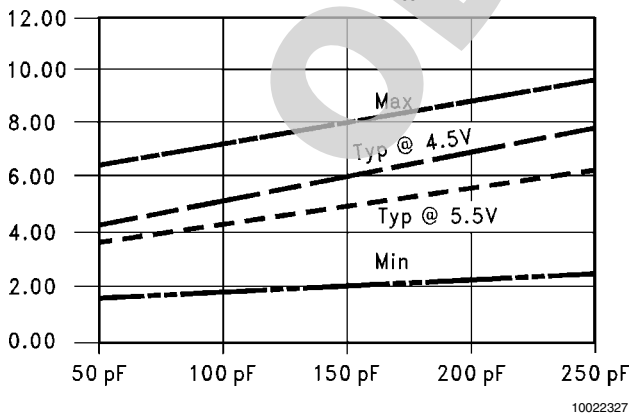
**$t_{PLZ}$  vs Temperature ( $T_A$ )**  
 $C_L = 50$  pF, 16 Outputs Switching



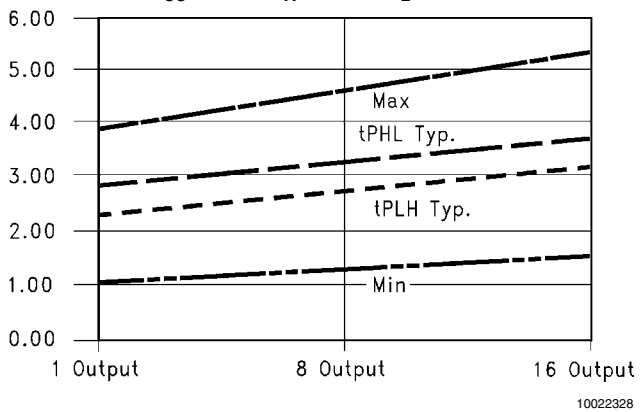
**$t_{PZL}$  vs Load Capacitance**  
 16 Outputs Switching,  $T_A = 25^\circ\text{C}$



**$t_{PZH}$  vs Load Capacitance**  
 16 Outputs Switching,  $T_A = 25^\circ\text{C}$

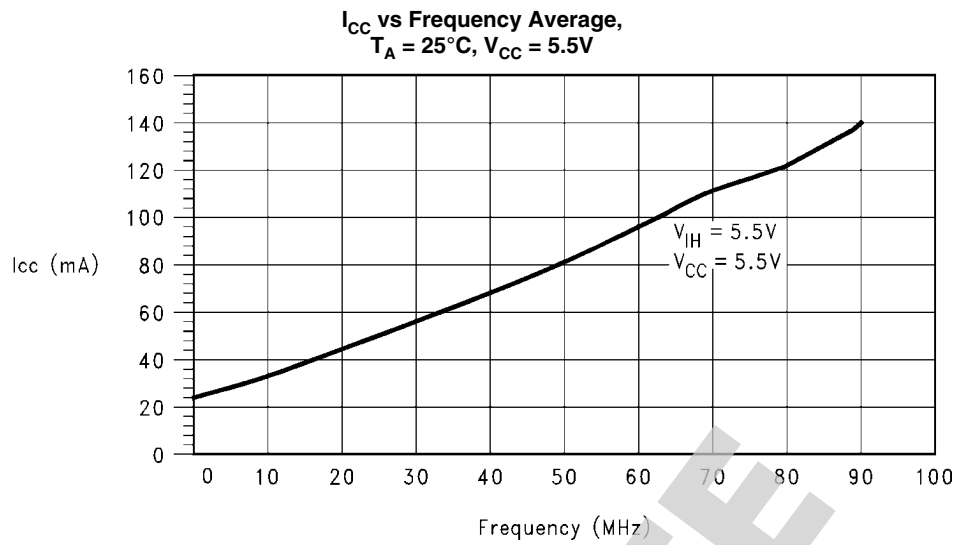


**$t_{PLH}$  and  $t_{PHL}$  vs Number Output Switching**  
 $V_{CC} = 5.0\text{V}$ ,  $T_A = 25^\circ\text{C}$ ,  $C_L = 50$  pF



Note: Dashed lines represent design characteristics; for specified guarantees, refer to AC Characteristics Tables.



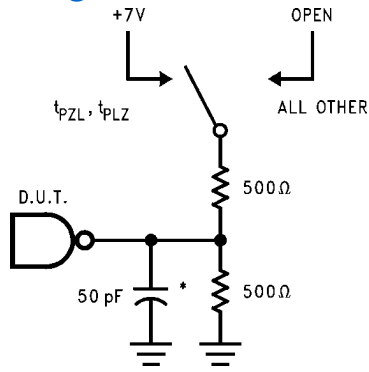


Note: Dashed lines represent design characteristics; for specified guarantees, refer to AC Characteristics Tables.

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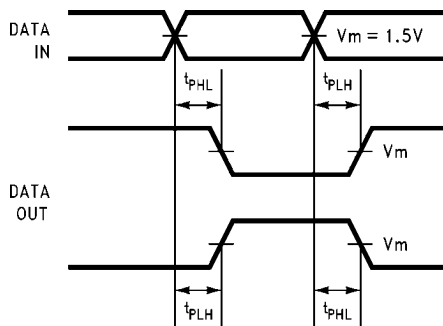
# AC Loading



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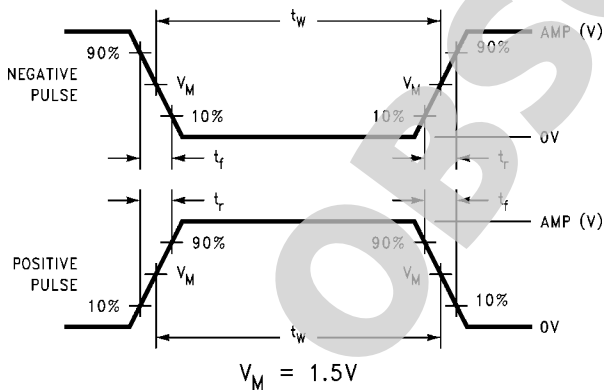
\*Includes jig and probe capacitance

FIGURE 1. Standard AC Test Load



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FIGURE 2. Propagation Delay Waveforms for Inverting and Non-Inverting Functions

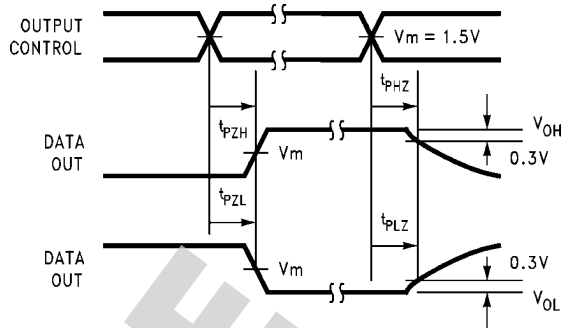


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FIGURE 3. Test Input Pulse Requirements

Amplitude	Rep Rate	$t_w$	$t_r$	$t_f$
3.0V	1 MHz	500 ns	2.5 ns	2.5 ns

FIGURE 4. Test Input Signal Requirements



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FIGURE 5. TRI-STATE Output HIGH and LOW Enable and Disable Times



# Notes

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## Notes

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